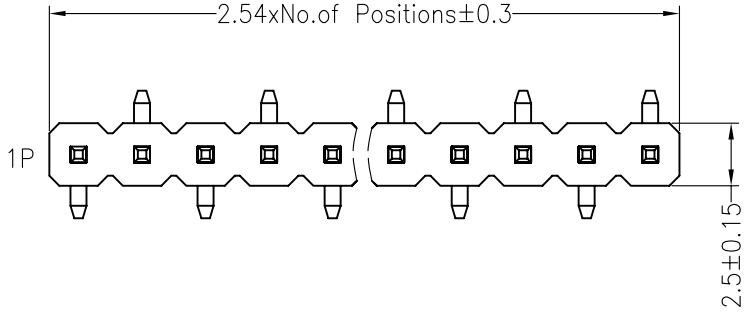
HSF RoHS

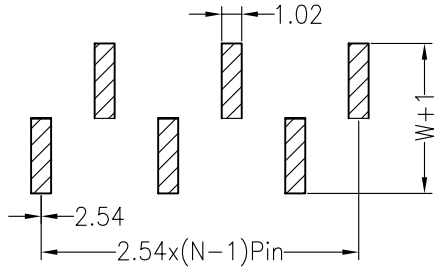
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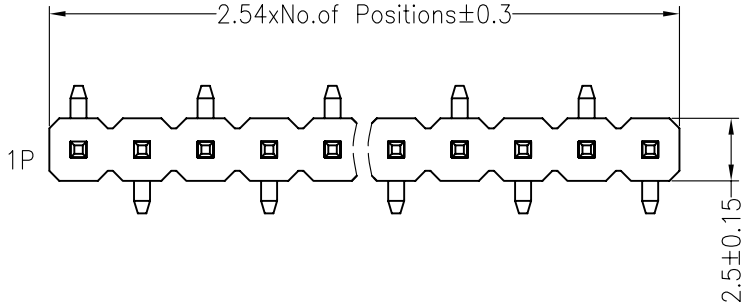
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

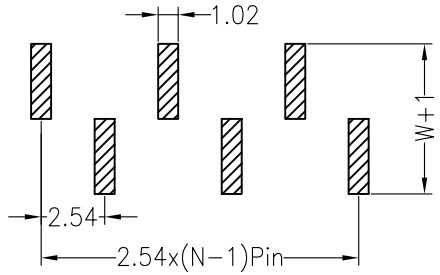


Type01

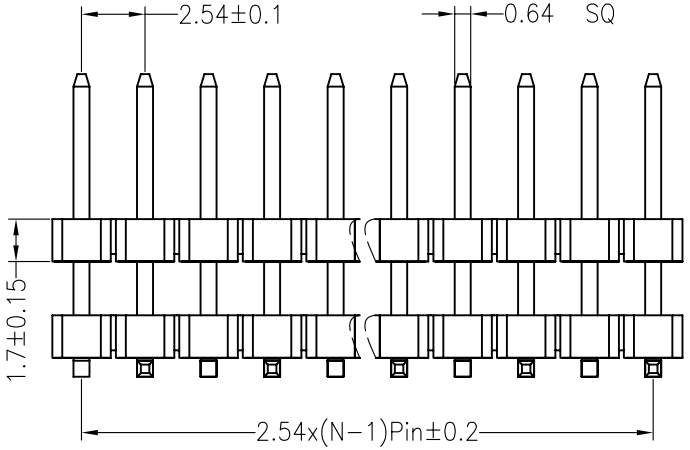


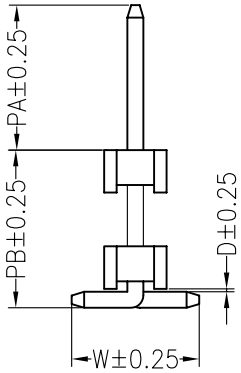


Type02



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)





Dimension antitheses list					
ITEM	PA	D	PB	W	L
Standard	6.00	0.20	4.30	5.00	12.10
Alternate					

Ordering Information

1217 2 1 XX X N XX M XXX X 01(2)

No.of Pins Per Row	Insulator Material Option	Post	Contact Plating	Pin Length	Packing
1*40	A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	W=With Post N=W/O Post	G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin		0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2013.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	13.03.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	121721XXXNXXMXXXX01(2)
TITLE:	2.54mm Pin Header 1.7+1.7mm SMT